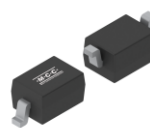


40V, 0.75A Schottky Barrier Diode

Product Summary

Parameter	Rating
V_{RRM}	40 V
$V_F \text{ Max @ } 750\text{mA}$	740 mV
$I_{F(AV)}$	750 mA
$I_R \text{ Max @ } V_F = 40 \text{ V}$	8 μA



Features

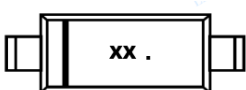

- Extremely Low Thermal Resistance
- For Surface Mount Application And High Current Capability

SOD-323

Mechanical Data

- Package: SOD-323
- Moisture Sensitivity: Level 1, per J-STD-020
- Halogen Free. "Green" Device ^(Note1)
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish & RoHS Compliant
- Weight: 0.004 g (approximate)

Body Marking and Pin Layout

Body Marking	Internal structure
 <p>XX: Device Marking Code¹ Bar: Cathode Pin indicator Dot(optional): Manufacturing Site Marking</p> <p>¹ Refer to the ordering information for the specific device code.</p>	

Ordering Information

Ordering Product Name	Device Marking Code	Reel Size	Packing Type	Qty/Reel
Product Name-TP	2G	7"	Tape & Reel	3,000
Product Name-13P	2G	13"	Tape & Reel	10,000

For packaging details, visit our website at <https://www.mccsemi.com/Package/List>

40V, 0.75A Schottky Barrier Diode

 Maximum Ratings ($T_A=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Rating	Unit
Peak Repetitive Reverse Voltage	V_{RRM}	40	V
RMS Reverse Voltage	$V_{R(RMS)}$	28	V
Reverse Voltage	V_R	40	V
Average Forward Current	$I_{F(AV)}$	750	mA
Non-Repetitive Peak Surge Current	I_{FSM}	10	A
$t_p= 8.3\text{ms Half Sine Wave, } T_J = 25^\circ\text{C}$			
Power Dissipation ^(Note 2)	P_D	380	mW
Operating Junction Temperature Range	T_J	-55 to +150	$^\circ\text{C}$
Storage Temperature Range	T_{STG}	-55 to +150	$^\circ\text{C}$

- Notes:
- Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 - Device mounted on an FR4 Printed-Circuit Board (PCB) with the recommended pad layout.

 Thermal characteristics ($T_A=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Rating	Unit
Thermal Resistance from Junction to Ambient ^(Note 2)	$R_{\theta JA}$	330	$^\circ\text{C/W}$

 Electrical Characteristics ($T_A=25^\circ\text{C}$ unless otherwise specified)

Parameter	Test Conditions	Symbol	Min	Typ	Max	Unit
Reverse Breakdown Voltage	$I_R=1\text{ mA (pulse test)}$	V_{BR}	40			V
Forward Voltage	$I_F = 10\text{ mA}$	V_F		0.29	0.38	V
	$I_F = 100\text{ mA}$			0.37	0.47	
	$I_F = 250\text{ mA}$			0.42	0.54	
	$I_F = 500\text{ mA}$			0.48	0.64	
	$I_F = 750\text{ mA}$			0.54	0.74	
Reverse Current	$V_R = 30\text{ V}$	I_R		1.2		μA
	$V_R = 40\text{ V}$			2	8	
	$V_R = 40\text{ V, } T_J=125^\circ\text{C}$			1.5		mA
Junction Capacitance	$V_R=10\text{ V, } f=1.0\text{MHz}$	C_J		15		pF
Reverse Recovery Time	$I_F=10\text{mA, } I_R=10\text{mA, } I_{rr}=0.1 \times I_R, R_L=100\Omega$	t_{rr}			20	ns

Curve Characteristics

Fig.1 - Typical Instantaneous Forward Characteristics (per diode)

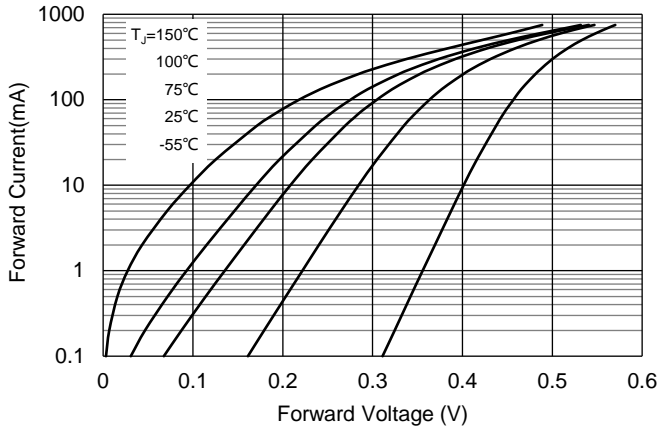


Fig.2 - Typical Reverse Leakage Characteristics (per diode)

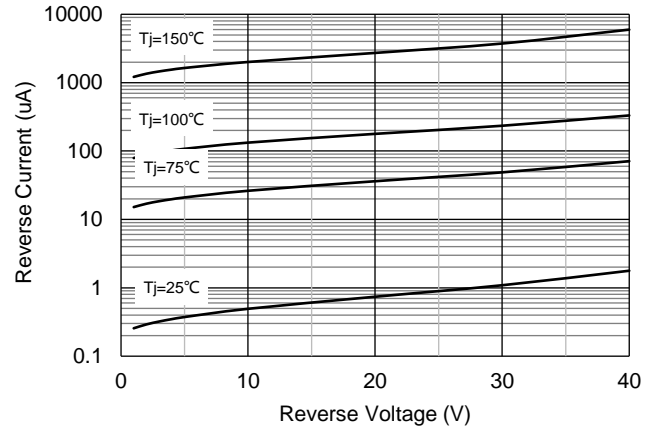


Fig.3 - Typical Capacitance Characteristics (per diode)

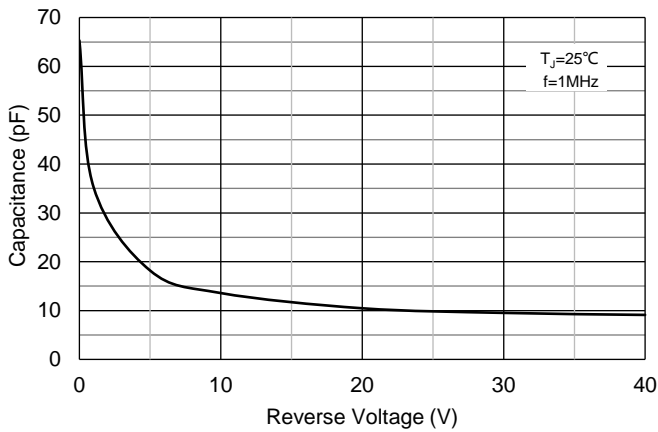
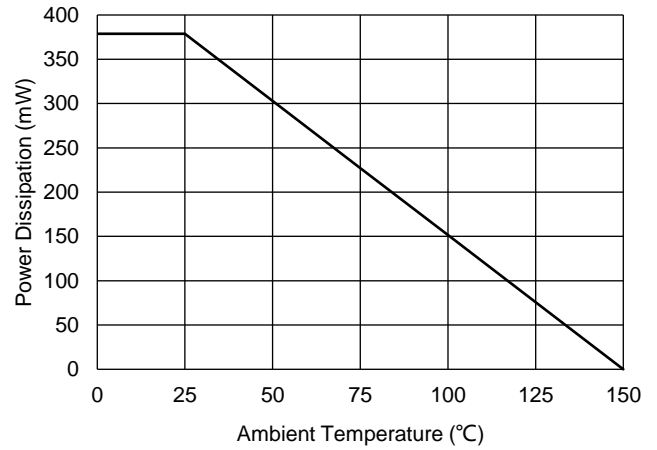
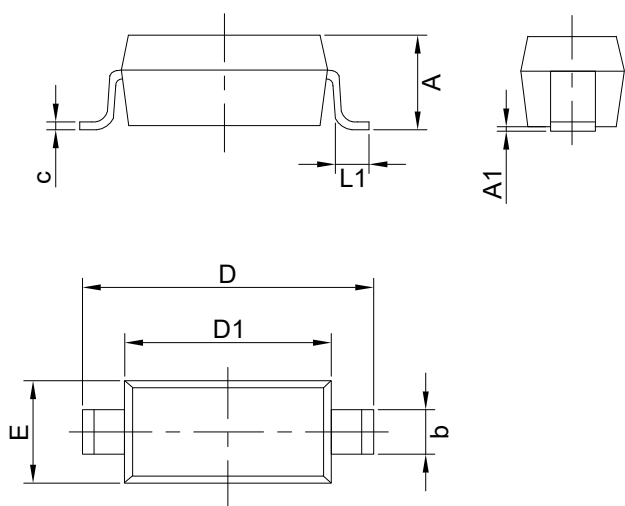


Fig.4 - Power Derating Curve



Package Outline

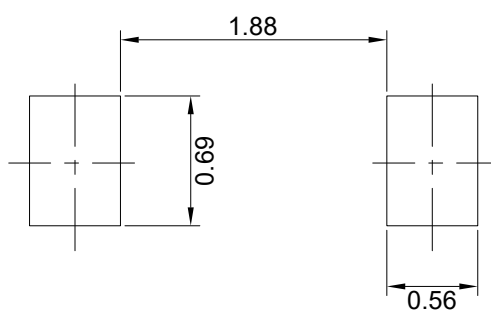


DIM	INCH		MM		NOTE
	MIN	MAX	MIN	MAX	
A	0.031	0.045	0.80	1.15*	Note 1
A1	0.000	0.006	0.00	0.15	
b	0.010	0.016	0.25	0.40	
c	0.003	0.010	0.08	0.25	
D	0.090	0.107	2.30	2.70	
D1	0.063	0.071	1.60	1.80	
E	0.045	0.055	1.15	1.40	
L1	0.004	0.018	0.10	0.45	

Notes:

1. Dimension A for products from manufacturing site VN is controlled at max 1.10 mm.

Suggested Pad Layout (Unit:mm)



Notes:

1. The suggested land pattern dimensions have been provided for reference only.
2. For further information, please refer to document IPC-7351A.

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